LP265,LP365

LP265 LP365 Micropower Programmable Quad Comparator



Literature Number: SNOSBC5A



LP265/LP365 Micropower Programmable Quad Comparator

General Description

Typical Connection

The LP365 consists of four independent voltage comparators. The comparators can be programmed, four at the same time, for various supply currents, input currents, response times and output current drives. This is accomplished by connecting a single resistor between the V_{CC} and I_{SET} pins.

These comparators can be operated from split power supplies or from a single power supply over a wide range of voltages. The input can sense signals at ground level even with single supply operation. The unique output NPN transistor stages are uncommitted to either power supply. They can be connected directly to various logic system supplies so that they are highly flexible to interface with various logic families.

Application areas include battery power circuits, threshold detectors, zero crossing detectors, simple serial A/D converters, VCO, multivibrators, voltage converters, power sequencers, and high performance V/F converters, and RTD linearization.

Features

- Single programming resistor to tailor power consumption, input current, speed and output current drive capability
- \blacksquare Wide single supply voltage range or dual supplies (4 V_{DC} to 36 V_{DC} or ± 2.0 V_{DC} to ± 18 V_{DC})
- \blacksquare Low supply current drain (10 $\mu A)$ and low power consumption (10 $\mu W/comparator)$ @ I_{SET} = 0.5 μA
- V_{CC} = 5_{VDC} ■ Uncommitted output stage—selectable output levels
- Output directly compatible with DTL, TTL, CMOS, MOS
- or other special logic families
- Input common-mode range includes ground
- Differential input voltage equal to the power supply voltage

Connection Diagram



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	ed devices are required, al Semiconductor Sales	Power Dissipation (Note 3) Τ _j Max θ _{jA}	M Package 500 mW 115℃ 115℃/W	N Package 500 mW 115℃ 90℃/W
ipply Voltage	36 V _{DC} or \pm 18 V _{DC}	Lead Temp.		
ential Input Voltage	\pm 36 V _{DC}	(Soldering—10 sec.)		260°C
(Note 1)	-0.3V to $+36$ V _{DC}	(Vapor Phase—60 sec.)	215°C	
0 ()	50	(Infrared—15 sec.)	220°C	
ut Short Circuit to V _E (Note	2) Continuous	Operating Temp. Range LP365:	0°C ≤	$T_{\Delta} \leq +70^{\circ}C$
_{IT} with Respect to V _E Tolerance (Note 10)	$V_{E} - 7V \le V_{OUT} \le V_{E} + 36V$ 2000V	Storage Temp. Range		$A \le +150$ °C

Electrical Characteristics (Note 4) Low power V_S=5V, I_{SET}=10 μ A

	Parameter	Conditions	LP365A			LP365			
Symbol			Тур	Tested Limit (Note 5)	Design Limit (Note 6)	Тур	Tested Limit (Note 5)	Design Limit (Note 6)	Units (Limit)
V _{OS}	Input Offset Voltage	V _{CM} =OV, R _S =100	1	3	6	3	6	9	mV (Max)
I _{OS}	Input Offset Current	V _{CM} =0V LP265	2	20	50	4	25	75	nA (Max)
IB	Input Bias	V _{CM} =0V	10	50	125	4 15	25 75	150 200	nA
	Current	LP265				15	75	300	(Max)
A _{VOL}	Large Signal Voltage Gain	R _L =100k	500	50	50	300	25	25	V/mV (Min)
V _{CM}	Input Common- Mode Voltage			0	0		0	0	V (Max)
	Range			3	3		3	3	V (Min)
CMRR	Common-Mode Rejection Ratio	$0 \le V_{CM} \le 3V$	85	75	70	80	75	70	dB (Min)
PSRR	Supply Voltage Rejection Ratio	$\pm 2.5V \le V_S$ $\le \pm 3.5V$	75	65	65	70	65	65	dB (Min)
IS	Supply Current	All Inputs = 0V, $R_L = \infty$	215	250	300	225	275	300	μA (Max)
V _{OH}	Output Voltage High	V _C =5V, V _E =0V, R _L =100k		4.9	4.5		4.9	4.5	V (Min)
V _{OL}	Output Voltage Low	V _E =0V		0.4	0.4		0.4	0.4	V (Max)
I _{SINK}	Output Sink Current	$V_{E} = 0V, V_{O} = 0.4V$	2.4	1.2	0.6	2.0	0.8	0.4	mA (Min)
I _{LEAK}	Output Leakage Current	$V_{C} = 5V,$ $V_{E} = 0V$	2	50	5000	2	100	5000	nA (Max)
t _R	Response Time	$V_{CC} = 5V,$ $V_E = 0V,$ $R_L = 5k,$ $C_L = 10 \text{ pF}$ (Note 7)	4			4			μs

	Parameter	Conditions	LP365A			LP365			
Symbol			Тур	Tested Limit (Note 5)	Design Limit (Note 6)	Тур	Tested Limit (Note 5)	Design Limit (Note 6)	Units (Limit)
V _{OS}	Input Offset Voltage	V _{CM} =0V, R _S =100	1	3	6	3	6	9	mV (Max)
I _{OS}	Input Offset Current	V _{CM} =0V LP265	5	50	100	10 10	90 90	200 500	nA (Max)
IB	Input Bias Current	V _{CM} =0V LP265	60	200	500	80 80	300 300	500 800	nA (Max)
A _{VOL}	Large Signal Voltage Gain	R _L =15k	500	100	100	500	100	100	V/m\ (Min)
V _{CM}	Input Common- Mode Voltage Range			-15	- 15		-15	- 15	V (Max
				13	13		13	13	V (Min)
CMRR	Common-Mode Rejection Ratio	−15V≤V _{CM} ≤13V	85	75	70	80	75	70	dB (Min)
PSRR	Supply Voltage Rejection Ratio	$\pm 10V \le V_S$ $\le \pm 15V$	80	70	70	75	70	70	dB (Min)
IS	Supply Current	All Inputs = 0V, $R_L = \infty$, LP265	2.6	3	3.3	2.8 2.8	3.5 3.5	3.7 4.3	mA (Max)
V _{OH}	Output Voltage High	$V_C = 5V,$ $V_E = 0V,$ $R_L = 100k$		4.9	4.5		4.9	4.5	V (Min)
V _{OL}	Output Voltage Low	V _E =0V		0.4	0.4		0.4	0.4	V (Max)
ISINK	Output Sink Current	V _E =0V, V _O =0.4V	10	8	5.5	7.5	6	4	mA (Min)
I _{LEAK}	Output Leakage Current	V _C =15V, V _E =-15V	5	50	5000	5	50	5000	nA (Max
t _R	Response Time	$V_{CC} = 5V,$ $V_E = 0V,$ $R_L = 5k,$ $C_L = 10 \text{ pF}$ (Note 7)	1.0			1.0			μs

Note 1: The input voltage is not allowed to go 0.3V above V⁺ or -0.3V below V⁻ as this will turn on a parasitic transistor causing large currents to flow through the device.

Note 2: Short circuits from the output to V⁺ may cause excessive heating and eventual destruction. The current in the output leads and the V_E lead should not be allowed to exceed 30 mA. The output should not be shorted to V⁻ if V_E \leq (V⁻) + 7V.

Note 3: For operating at elevated temperatures, these devices must be derated based on a thermal resistance of θ_{jA} and T_j max. $T_j = T_A + \theta_{jA} P_D$.

Note 4: Boldface numbers apply at temperature extremes. All other numbers apply at $T_A = T_j = 25^{\circ}C$, $V^+ = 5V$, $V^- = 0V$, $I_{SET} = 10 \ \mu$ A, $R_L = 100k$, and $V_C = 5V$ as shown in the Typical Connection diagram.

Note 5: Guaranteed and 100% production tested.

Note 6: Guaranteed (but not 100% production tested) over the operating temperature and supply voltage ranges. These limits are not used to calculate out-going quality levels.

Note 7: The response time specified is for a 100 mV input step with 5 mV overdrive.

Note 8: Boldface numbers apply at temperature extremes. All other numbers apply at $T_A = T_j = 25^{\circ}$ C. V⁺ = + 15V, V⁻ = -15V, I_{SET} = 100 μ A, R_L = 100k, and V_C = 5V as shown in the Typical Connection diagram.

Note 9: See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

Note 10: Human body model, 1.5 k Ω in series with 100 pF.















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